

# 2SK2581(Tentative)

## Silicon N-Channel Power F-MOS

## ■ Features

- Avalanche energy capability guaranteed
  - High-speed switching
  - Low ON-resistance
  - No secondary breakdown
  - Low-voltage drive

## ■ Applications

- Non-contact relay
  - Solenoid drive
  - Motor drive
  - Control equipment
  - Switching mode regulator

## ■ Absolute Maximum Ratings ( $T_c = 25^\circ\text{C}$ )

Parameter	Symbol	Rating	Unit
Drain-Source breakdown voltage	V <sub>DSS</sub>	100	V
Gate-Source voltage	V <sub>GSS</sub>	±20	V
Drain current	DC	I <sub>D</sub>	±5
	Pulse	I <sub>DP</sub>	±10
Avalanche energy capability	EAS *	1.25	mJ
Allowable power dissipation	T <sub>C</sub> = 25°C	P <sub>D</sub>	30
	T <sub>a</sub> = 25°C		2
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

\*  $L = 0.1\text{mH}$ ,  $I_L = 5\text{A}$ , 1 pulse

### ■ Electrical Characteristics ( $T_c = 25^\circ\text{C}$ )

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Drain-Source cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> =80V, V <sub>GS</sub> =0			10	µA
Gate-Source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0			±1	µA
Drain-Source breakdown voltage	V <sub>DSS</sub>	I <sub>D</sub> =1mA, V <sub>GS</sub> =0	100			V
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	1		2.5	V
Drain-Source ON-resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A		315	470	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> =4V, I <sub>D</sub> =2A		400	600	mΩ
Forward transadmittance	Y <sub>fs</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =3A	2.5	3.8		S
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> =5A, V <sub>GS</sub> =0			-1.6	V
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0, f=1MHz		416		pF
Output capacitance	C <sub>oss</sub>			135		pF
Feedback capacitance	C <sub>rss</sub>			38		pF
Turn-on time	t <sub>on</sub>	V <sub>DD</sub> =30V, I <sub>D</sub> =3A V <sub>GS</sub> =10V, R <sub>L</sub> =10Ω		26		ns
Fall time	t <sub>f</sub>			38		ns
Turn-off time (delay time)	t <sub>d(off)</sub>			84		ns
Channel-Case heat resistance	R <sub>th(ch-c)</sub>				4.17	°C/W
Channel-Atmosphere heat resistance	R <sub>th(ch-a)</sub>				62.5	°C/W



